

Mar. 2, 2009 11:42AM      HUDAK SHUNK & FARINE

No. 4534 P. 1/7

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Dingwei Lu      Examiner: Jermie E. Cozart

Serial No.: 10/519,896      Group Art Unit: 3726

Filed: 01/31/2005      Date: 03/02/2009

Customer No.: 28862      Docket No.: CNIP-B-PCT-US

For: **A MOULDING PROCESS OF COMPOSITE MATERIAL INCLUDING HIGH-THERMAL CONDUCTOR AND ROOM-TEMPERATURE MAGNETIC REFRIGERANT**

**Mail Stop AMENDMENT**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

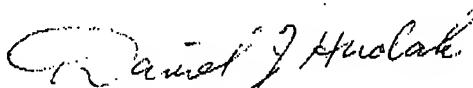
**CERTIFICATION OF FACSIMILE TRANSMISSION**  
(Facsimile: No. 1-571-273-8300 – 7 Pages)

Sir:

The undersigned hereby certifies that the attached **SUPPLEMENTAL AMENDMENT "B"** is being transmitted herewith via facsimile to the Mail Stop AMENDMENTS, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313, on **March 2, 2009**. Thus, timely response has been made to the outstanding Office action prior to expiration of the shortened statutory period for the same ending **NONE**.

Respectfully submitted,

HUDAK, SHUNK & FARINE CO. LPA



By: Daniel J. Hudak  
Registration No. 25,879

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**SUPPLEMENTAL AMENDMENT "B"**

In response to telephone interview of February 5, 2009, Applicant responds as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.